

2-input NAND Gate

REJ03D0191-0500Z (Previous ADE-205-301C (Z)) Rev.5.00 Jan.28.2004

# Description

The HD74HCT1G00 is high-speed CMOS two input NAND gate using silicon gate CMOS process. With CMOS low power dissipation, it provides high-speed equivalent to LS–TTL series. The internal circuit of three stages construction with buffer provides wide noise margin and stable output.

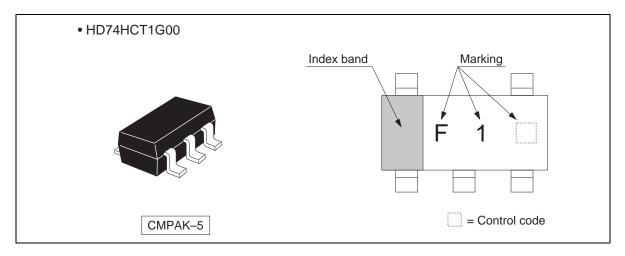
# Features

- The basic gate function is lined up as Renesas uni logic series.
- Supplied on emboss taping for high-speed automatic mounting.
- TTL compatible input level. Supply voltage range : 4.5 to 5.5 V Operating temperature range : -40 to +85°C
- $|I_{OH}| = I_{OL} = 2 \text{ mA (min)}$
- Ordering Information

Part Name	Package Type	Package Code	Package Abbreviation	Taping Abbreviation (Quantity)
HD74HCT1G00CME	CMPAK-5 pin	CMPAK-5V	СМ	E (3,000 pcs/reel)



# **Outline and Article Indication**



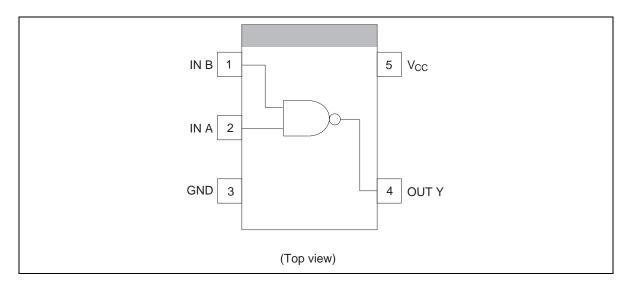
# **Function Table**

Inputs			
Α	В	Output Y	
L	L	Н	
L	Н	Н	
Н	L	Н	
Н	Н	L	

H : High level

L : Low level

# **Pin Arrangement**





## **Absolute Maximum Ratings**

Item	Symbol	Ratings	Unit	Test Conditions
Supply voltage range	V <sub>CC</sub>	–0.5 to 7.0	V	
Input voltage range *1	VI	–0.5 to V <sub>CC</sub> + 0.5	V	
Output voltage range *1, 2	Vo	–0.5 to V <sub>CC</sub> + 0.5	V	Output : H or L
Input clamp current	I <sub>IK</sub>	±20	mA	$V_I < 0 \text{ or } V_I > V_{CC}$
Output clamp current	Ι <sub>ΟΚ</sub>	±20	mA	$V_{\rm O}$ < 0 or $V_{\rm O}$ > $V_{\rm CC}$
Continuous output current	lo	±25	mA	$V_0 = 0$ to $V_{CC}$
Continuous current through $V_{CC}$ or GND	$I_{CC}$ or $I_{GND}$	±25	mA	
Maximum power dissipation at Ta = $25^{\circ}$ C (in still air) <sup>*3</sup>	P <sub>T</sub>	200	mW	
Storage temperature	Tstg	–65 to 150	°C	

Notes: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

- 2. This value is limited to 5.5 V maximum.
- 3. The maximum package power dissipation was calculated using a junction temperature of 150°C.

# **Recommended Operating Conditions**

Item	Symbol	Min	Max	Unit	Test Conditions
Supply voltage range	Vcc	4.5	5.5	V	
Input voltage range	VI	0	5.5	V	
Output voltage range	Vo	0	V <sub>CC</sub>	V	
Output current	IOL	_	2	mA	$V_{CC}$ = 4.5 to 5.5 V
	I <sub>OH</sub>		-2		$V_{CC}$ = 4.5 to 5.5 V
Input rise / fall time (0.3 V to 2.7 V)	t <sub>r</sub> , t <sub>f</sub>	0	500	ns	$V_{CC}$ = 4.5 to 5.5 V
Operating temperature	Та	-40	85	°C	

Note: Unused or floating inputs must be held high or low.



# **Electrical Characteristics**

					Vcc	T <sub>a</sub> = 2	5°C		$T_a = -4$	10 to 85°C			
Item	Symbol	(V)	Min	Тур	Max	Min	Max	Unit	Test Conditions				
Input voltage	V <sub>IH</sub>	4.5 to 5.5	2.0	—	—	2.0	_	V					
	VIL	4.5 to 5.5	—	—	0.8	—	0.8	-					
Output voltage	V <sub>OH</sub>	4.5	4.4	4.5	_	4.4	—	V	V <sub>IN</sub> =	I <sub>OH</sub> = -20 μA			
		4.5	4.18	4.31	_	4.13	—	-	$V_{\text{IH}} \text{ or } V_{\text{IL}}$	$I_{OH} = -2 \text{ mA}$			
	V <sub>OL</sub>	4.5	—	0.0	0.1	_	0.1	-		I <sub>OL</sub> = 20 μA			
		4.5	—	0.17	0.26	—	0.33	-		$I_{OL} = 2 \text{ mA}$			
Input current	l <sub>IN</sub>	5.5	_	_	±0.1	_	±1.0	μΑ	$V_{IN} = V_{CC}$ or GND				
Operating current	I <sub>CC</sub>	5.5		_	1.0	_	10.0	μA	$V_{IN} = V_{CC}$ or GND				
Quiescent supply current	I <sub>CCT</sub>	5.5	_	_	2.0	_	2.9	mA	One input $V_{IN} = 2.4 V$ , other input $V_{CC}$ or GND				



# **Switching Characteristics**

		Ta = 25	°C				
Item	Symbol	Min	Тур	Тур Мах		Test Conditions	
Output rise / fall time	t <sub>TLH</sub> t <sub>THL</sub>	_	5	10	ns	Test circuit	
Propagation delay time	t <sub>PLH</sub>	_	6.9	12	ns	Test circuit	
	t <sub>PHL</sub>		9.8	17			

 $(C_L = 15 \text{ pF}, t_r = t_f = 6 \text{ ns}, V_{CC} = 5 \text{ V})$ 

		Vcc	Ta = 25°C		Ta = –4	10 to 85°C			
Item	Symbol	(V)	Min	Тур	Max	Min	Max	Unit	Test Conditions
Output rise / fall time	t <sub>TLH</sub> t <sub>THL</sub>	4.5	_	14	25	_	31	ns	Test circuit
Propagation delay time	t <sub>PLH</sub>	4.5		10.5	16	_	20	ns	Test circuit
	t <sub>PHL</sub>	4.5	—	16.0	27	_	31	_	
Input capacitance	CIN	_	—	2.5	5	_	5	pF	
Equivalent capacitance	C <sub>PD</sub>			10			—	pF	

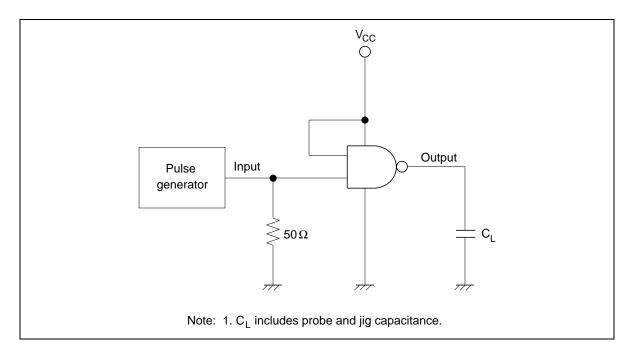
 $(C_L = 50 \text{ pF}, t_r = t_f = 6 \text{ ns})$ 

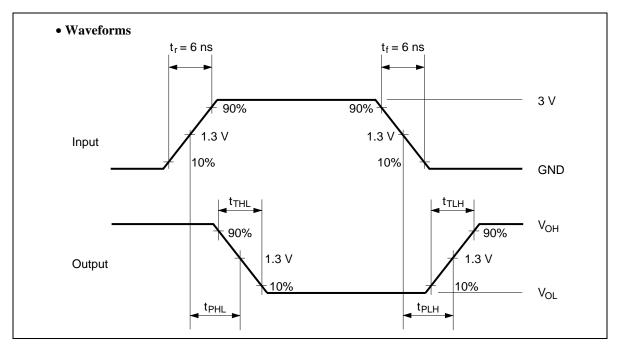
Note: C<sub>PD</sub> is equivalent capacitance inside of the IC calculated from the operating current without load (see test circuit). The average operating current without load is calculated according to the expression below.

 $I_{CC}$  (opr) =  $C_{PD} \bullet V_{CC} \bullet f_{IN} + I_{CC}$ 



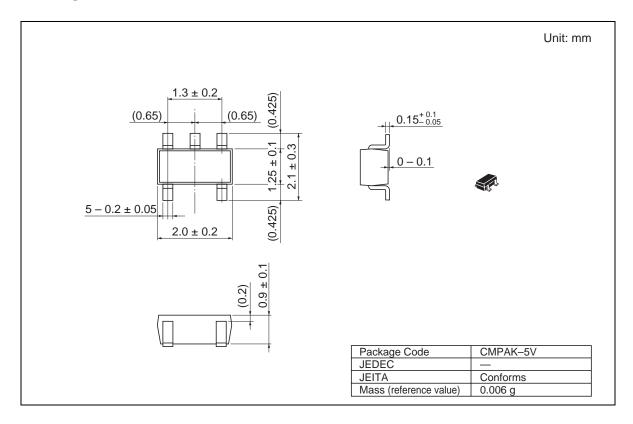
# **Test Circuit**







# **Package Dimensions**





### Renesas Technology Corp. Sales Strategic Planning Div. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan

Keep safety first in your circuit designs! 1. Renesas Technology Corp. puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage. Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of nonflammable material or (iii) prevention against any malfunction or mishap.

### Notes regarding these materials

- Notes regarding these materials
  1. These materials are intended as a reference to assist our customers in the selection of the Renesas Technology Corp. product best suited to the customer's application; they do not convey any license under any intellectual property rights, or any other rights, belonging to Renesas Technology Corp. or a third party.
  2. Renesas Technology Corp. assumes no responsibility for any damage, or infringement of any third-party's rights, originating in the use of any product data, diagrams, charts, programs, algorithms, or circuit application examples contained in these materials.
  3. All information contained in these materials, including product data, diagrams, charts, programs and algorithms represents information on products at the time of publication of these materials, and are subject to change by Renesas Technology Corp. without notice due to product improvements or other reasons. It is therefore recommended that customers contact Renesas Technology Corp. or an authorized Renesas Technology Corp. product distributor for the latest product information before purchasing a product listed herein.
  The information before purchasing a product listed herein.
  The information described here may contain technical inaccuracies or typographical errors.
  Renesas Technology Corp. assumes no responsibility for any damage, ilability, or other loss rising from these inaccuracies or errors.
  Please also pay attention to information published by Renesas Technology Corp. by various means, including the Renesas Technology Corp. Semiconductor home page (http://www.renesas.com).
  When using any or all of the information contained in these materials, including product data, diagrams, charts, programs, and algorithms, please be sure to evaluate all information as a total system before making a final decision on the applicability of the information and products. Renesas Technology Corp. assumes no responsibility for unter loss resu

- use. 6. The prior written approval of Renesas Technology Corp. is necessary to reprint or reproduce in whole or in part these materials. 7. If these products or technologies are subject to the Japanese export control restrictions, they must be exported under a license from the Japanese government and
- a mode products of country other than the approved destination.
   Any diversion or reexport contrary to the export control laws and regulations of Japan and/or the country of destination is prohibited.
   8. Please contact Renesas Technology Corp. for further details on these materials or the products contained therein.



### **RENESAS SALES OFFICES**

### Renesas Technology America, Inc.

450 Holger Way, San Jose, CA 95134-1368, U.S.A Tel: <1> (408) 382-7500 Fax: <1> (408) 382-7501

Renesas Technology Europe Limited. Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, United Kingdom Tel: <44> (1628) 585 100, Fax: <44> (1628) 585 900

Renesas Technology Europe GmbH Dornacher Str. 3, D-85622 Feldkirchen, Germany Tel: <49> (89) 380 70 0, Fax: <49> (89) 929 30 11

Renesas Technology Hong Kong Ltd. 7/F., North Tower, World Finance Centre, Harbour City, Canton Road, Hong Kong Tel: <852> 2265-6688, Fax: <852> 2375-6836

Renesas Technology Taiwan Co., Ltd. FL 10, #99, Fu-Hsing N. Rd., Taipei, Taiwan Tel: <886> (2) 2715-2888, Fax: <886> (2) 2713-2999

Renesas Technology (Shanghai) Co., Ltd. 26/F., Ruijin Building, No.205 Maoming Road (S), Shanghai 200020, China Tel: <86> (21) 6472-1001, Fax: <86> (21) 6415-2952

Renesas Technology Singapore Pte. Ltd. 1, Harbour Front Avenue, #06-10, Keppel Bay Tower, Singapore 098632 Tel: <65> 6213-0200, Fax: <65> 6278-8001

© 2004. Renesas Technology Corp., All rights reserved. Printed in Japan. Colophon .1.0

http://www.renesas.com